

GPU SuperServer SYS-A22GA-NBRT

DP Intel 10U System with NVIDIA HGX B200 8-GPU



More details here

Key Applications

Scientific Research, Conversational AI, Business Intelligence & Analytics, Drug Discovery, Finance Services and Fraud Detection, AI/Deep Learning Training and Inference, Large Language Model (LLM) and Generative AI, High Performance Computing (HPC), Autonomous Vehicle Technologies,

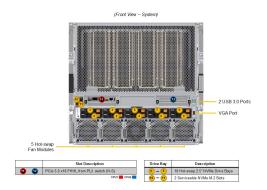
Key Features

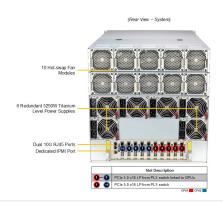
- Dual Intel® Xeon® 6900 series processors with P-cores;
- 8x NVIDIA SXM B200 GPUs, 1.4TB of GPU memory space;
- 24x DIMM slots, ECC RDIMM / MRDIMM DDR5 up to 8800MT/s (1DPC);
- 10x PCle 5.0 x16 LP, 2x PCle 5.0 x16 FHHL slots;
- 10x front hot-swap 2.5" NVMe U.2, 2x front hot-swap NVMe M.2;
- 2x 10GbE RJ-45, 1x Dedicated BMC/IPMI;



10U Rackmount Enclosure: 449 x 438.8 x 843.28mm (17.6" x 17.2" x 33.2") Package: 1255 x 640 x 694mm (49.4" x 25.2" x 27.3") Dual Socket BR (LGA-7529) Intel® Xeon® 6900 series processors with P-cores Up to 128C/256T; Up to 504MB Cache per CPU Max GPU Count: 8 onboard GPUs Supported GPU: NVIDIA SXM: HGX B200 8-GPU (180GB) CPU-GPU Interconnect: PCIe 5.0 x16 CPU-to-GPU Interconnect GPU-GPU Interconnect: NVIDIA® NVLink® with NVSwitch™
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Slot Count: 24 DIMM slots
Max Memory (1DPC): Up to 6TB 6400MT/s ECC DDR5 RDIMM
Max Memory (1DPC): Up to 6TB 8800MT/s ECC DDR5 MRDIMM
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Default: Total 10 bays
 10 front hot-swap 2.5" PCIe 5.0 x4 NVMe drive bays
M.2: 2 M.2 PCIe 4.0 x4 NVMe slots (M-key 2280/22110)
Default
• 10 PCIe 5.0 x16 LP slots
• 2 PCIe 5.0 x16 FHHL slots
• 2 FCIE 3.0 X10 FITTLE SIOUS
Chipset: System on Chip
Network Connectivity: 2 RJ45 10GbE with Intel® X710
LAN: 1 RJ45 1 GbE Dedicated BMC LAN port
USB: 2 USB 3.0 ports(rear)
Video: 1 VGA port
TPM: 1 TPM header
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System Cooling	Fans: 15 counter-rotating 80x80x80mm Fan(s)
	4 counter-rotating 60x60x56mm Fan(s)

Air Shroud: 1 Air Shroud

Power Supply 6x 5250W Redundant (3 + 3) Titanium Level (96%) power supplies

System BIOS BIOS Type: AMI 64MB UEFI

Management SuperCloud Composer®; Supermicro Server Manager (SSM); Super Diagnostics Offline (SDO); Supermicro Thin-

Agent Service (TAS); SuperServer Automation Assistant (SAA) New!

PC Health Monitoring CPU: Monitors for CPU Cores, Chipset Voltages, Memory

FAN: Fans with tachometer monitoring Status monitor for speed control

Pulse Width Modulated (PWM) fan connectors Temperature: Monitoring for CPU and chassis environment

Thermal Control for fan connectors

Dimensions and Weight Weight: Gross Weight: 341 lbs (155 kg)

Net Weight: 293 lbs (133 kg)

Available Color: Silver

Operating Environment Operating Temperature: 10°C to 35°C (50°F to 95°F)

Non-operating Temperature: -40°C to 70°C (-40°F to 158°F) Operating Relative Humidity: 8% to 90% (non-condensing) Non-operating Relative Humidity: 5% to 95% (non-condensing)

Motherboard Super X14DBG-DAP

Chassis CSE-GP1001TS-R000NPF